



### **General Description**

The MAX1790/MAX8715 boost converters incorporate high-performance (at 1.2MHz), current-mode, fixed-frequency, pulse-width modulation (PWM) circuitry with a built-in  $0.21\Omega/0.15\Omega$  n-channel MOSFET to provide a highly efficient regulator with fast response.

High switching frequency (640kHz or 1.2MHz selectable) allows easy filtering and faster loop performance. An external compensation pin provides the user flexibility in determining loop dynamics, allowing the use of small, low equivalent-series-resistance (ESR) ceramic output capacitors. The device can produce an output voltage as high as 12V from an input as low as 2.6V.

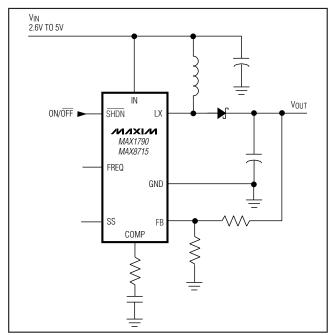
Soft-start is programmed with an external capacitor, which sets the input-current ramp rate. In shutdown mode, current consumption is reduced to 0.1µA. The MAX1790/ MAX8715 are available in a space-saving 8-pin µMAX® package. The ultra-small package and high switching frequency allow the total solution to be less than 1.1mm high.

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**Applications** 

LCD Displays **PCMCIA Cards** Portable Applications Hand-Held Devices

### Typical Operating Circuit



**Features** 

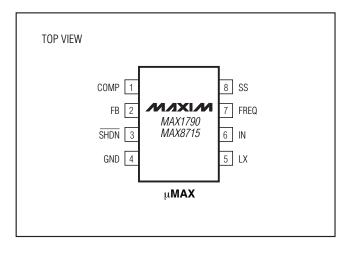
- ♦ 90% Efficiency
- Adjustable Output from V<sub>IN</sub> to 12V
- ♦ 1.6A, 0.21Ω, 14V Power MOSFET (MAX1790)
- ♦ 2.4A, 0.15Ω, 14V Power MOSFET (MAX8715)
- ♦ +2.6V to +5.5V Input Range
- ♦ Pin-Selectable 640kHz or 1.2MHz Switching Frequency
- ♦ 0.1µA Shutdown Current
- ♦ Programmable Soft-Start
- ♦ Small 8-Pin µMAX Package

### **Ordering Information**

PART	TEMP RANGE	PIN-PACKAGE
MAX1790EUA	-40°C to +85°C	8 µMAX
MAX1790EUA+	-40°C to +85°C	8 µMAX
MAX8715EUA	-40°C to +85°C	8 µMAX
MAX8715EUA+	-40°C to +85°C	8 µMAX

+ Denotes lead-free package.

### **Pin Configuration**



MIXIM

Maxim Integrated Products 1

For pricing, delivery, and ordering information, please contact Maxim/Dallas Direct! at 1-888-629-4642, or visit Maxim's website at www.maxim-ic.com.

### **ABSOLUTE MAXIMUM RATINGS**

LX to GND	0.3V to +14V
IN, SHDN, FREQ, FB to GND	0.3V to +6.2V
SS, COMP to GND	0.3V to $(V_{IN} + 0.3V)$
RMS LX Pin Current	1.2A
Continuous Power Dissipation (T <sub>A</sub> =	+70°C)
8-Pin μMAX (derate 4.1mW/°C abo	ove +70°C)330mW

Operating Temperature Range	
MAX1790EUA/MAX8715EUA	40°C to +85°C
Junction Temperature	+150°C
Storage Temperature Range	65°C to +150°C
Lead Temperature (soldering, 10s)	+300°C

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

### **ELECTRICAL CHARACTERISTICS**

 $(V_{IN} = \overline{SHDN} = 3V, FREQ = GND, T_A = 0^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted. Typical values are at } T_A = +25^{\circ}C.)$ 

PARAMETER	SYMBOL	CONDITIONS		MIN	TYP	MAX	UNITS	
Input Supply Range	VIN			2.6		5.5	V	
V <sub>IN</sub> Undervoltage Lockout	UVLO	V <sub>IN</sub> rising, typica LX remains off be	I hysteresis is 40mV, elow this level	2.25	2.38	2.52	V	
		MAX1790	V <sub>FB</sub> = 1.3V, not switching		0.18	0.35		
Quiescent Current	1	WAX 1790	V <sub>FB</sub> = 1.0V, switching		2	5		
Quiescent Current	IIN	MAX8715	V <sub>FB</sub> = 1.3V, not switching		0.21	0.35	mA	
		IVIAA6713	V <sub>FB</sub> = 1.0V, switching		2.5	5.0		
Shutdown Supply Current	I <sub>IN</sub>	SHDN = GND			0.1	10	μΑ	
ERROR AMPLIFIER								
Feedback Voltage	V <sub>FB</sub>	Level to produce	V <sub>COMP</sub> = 1.24V	1.222	1.24	1.258	V	
ED Input Dice Current	les	\/=p 1 04\/	MAX1790		0	40	nA	
FB Input Bias Current	I <sub>FB</sub>	$V_{FB} = 1.24V$	MAX8715		125	190		
Feedback-Voltage Line Regulation		Level to produce 2.6V < V <sub>IN</sub> < 5.5V	V <sub>COMP</sub> = 1.24V,		0.05	0.15	%/V	
		$\Delta I = 5\mu A$	MAX1790	70	140	240	μS	
Transconductance	9m		MAX8715	70	160	240		
Voltage Gain	Av				700		V/V	
OSCILLATOR								
		FREQ = GND		540	640	740		
Frequency	fosc	FREQ = IN		1000	1220	1500	kHz	
Manifestore Duty Coula	D0	FREQ = GND		79	85	92	%	
Maximum Duty Cycle	DC	FREQ = IN			84		%	
N-CHANNEL SWITCH								
Current Limit	ILIM	V <sub>FB</sub> = 1V, duty cycle =	MAX1790	1.2	1.6	2.3	A	
Curcii Liriii	'LIIVI	65% (Note 1)	MAX8715	1.8	2.4	3.4		
On-Resistance	RON	MAX1790			0.21	0.5		
OH-HESISIANICE	HON	MAX8715			0.15	0.35	Ω	
Leakage Current	luvoss	10)/	MAX1790		0.01	20		
Leanage Current	lLXOFF	$V_{LX} = 12V$	MAX8715		5	30	μΑ	

2 /VI/IXI/VI

### **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{IN} = \overline{SHDN} = 3V, FREQ = GND, T_A = 0^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted. Typical values are at } T_A = +25^{\circ}C.)$ 

PARAMETER	SYMBOL	CONDITIONS	MIN	TYP	MAX	UNITS
Current-Sense Transresistance	Doo	MAX1790	0.30	0.45	0.65	V/A
Current-Sense Transfesistance	Rcs	MAX8715	0.20	0.30	0.43	
SOFT-START						
Reset Switch Resistance					100	Ω
Charge Current		V <sub>SS</sub> = 1.2V	1.5	4	7.0	μΑ
CONTROL INPUTS						
Input Low Voltage	VIL	SHDN, FREQ			0.3 x V <sub>IN</sub>	V
Input High Voltage	VIH	SHDN, FREQ	0.7 x V <sub>IN</sub>			V
Hysteresis		SHDN, FREQ		0.1 x V <sub>II</sub>	7	>
FREQ Pulldown Current	IFREQ		1.8	5	9.0	μΑ
SHDN Input Current	ISHDN			0.001	1	μΑ

### **ELECTRICAL CHARACTERISTICS**

 $(V_{IN} = \overline{SHDN} = 3V, FREQ = GND, T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted.})$  (Note 2)

PARAMETER	SYMBOL	С	ONDITIONS	MIN	TYP	MAX	UNITS
Input Supply Range	V <sub>IN</sub>			2.6		5.5	V
V <sub>IN</sub> Undervoltage Lockout	UVLO	V <sub>IN</sub> rising, typical LX remains off be	I hysteresis is 40mV, elow this level	2.25		2.52	V
		MAX1790	V <sub>FB</sub> = 1.3V, not switching			0.35	
	1	MAX 1790	V <sub>FB</sub> = 1.0V, switching			5	A
Quiescent Current	IIN	MAX8715	V <sub>FB</sub> = 1.3V, not switching			0.35	mA
		IVIAX87 IS	V <sub>FB</sub> = 1.0V, switching			5	1
Shutdown Supply Current	I <sub>IN</sub>	SHDN = GND				10	μΑ
ERROR AMPLIFIER							
Feedback Voltage	V <sub>FB</sub>	Level to produce	$V_{COMP} = 1.24V$	1.215	1.24	1.260	V
ED locat Dies Comment	I <sub>FB</sub>	V <sub>FB</sub> = 1.24V MAX1790 MAX8715				40	nA
FB Input Bias Current						190	
Feedback-Voltage Line Regulation		Level to produce V <sub>COMP</sub> = 1.24V, 2.6V < V <sub>IN</sub> < 5.5V				0.15	%/V
			MAX1790	70		260	0
Transconductance g <sub>m</sub>		$\Delta I = 5\mu A$ MAX8715		70		260	μS
OSCILLATOR							
F	<b>f</b>	FREQ = GND		490		770	1.1.1=
Frequency	fosc	FREQ = IN		900		1500	kHz
Maximum Duty Cycle	DC	FREQ = GND		78		92	%

### **ELECTRICAL CHARACTERISTICS (continued)**

 $(V_{IN} = \overline{SHDN} = 3V, FREQ = GND, T_A = -40^{\circ}C \text{ to } +85^{\circ}C, \text{ unless otherwise noted.})$  (Note 2)

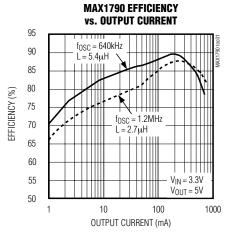
PARAMETER	SYMBOL		CONDITIONS	MIN T	YP MAX	UNITS		
N-CHANNEL SWITCH								
Course at Lineit	1	V <sub>FB</sub> = 1V, duty cycle = 65% (Note 1)	MAX1790	1.2	2.3	- A		
Current Limit	ILIM		MAX8715	1.8	3.0			
0. 5	R <sub>ON</sub>	MAX1790			0.5	0		
On-Resistance		MAX8715			0.35	Ω		
Comment Comment Transport	D	MAX1790	MAX1790		0.65	V/A		
Current-Sense Transresistance	Rcs	MAX8715		0.20	0.43			
CONTROL INPUTS								
Input Low Voltage	VIL	SHDN, FREQ			0.3 x V <sub>IN</sub>	V		
Input High Voltage	VIH	SHDN, FREQ	SHDN, FREQ			V		

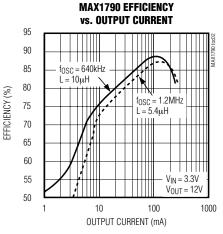
Note 1: Current limit varies with duty cycle due to slope compensation. See the Output-Current Capability section.

Note 2: Specifications to -40°C are guaranteed by design and not production tested.

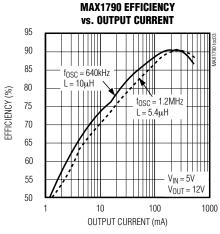
### **Typical Operating Characteristics**

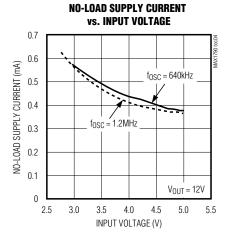
(Circuit of Figure 1, V<sub>IN</sub> = 3.3V, f<sub>OSC</sub> = 640kHz, T<sub>A</sub> = +25°C, unless otherwise noted.)

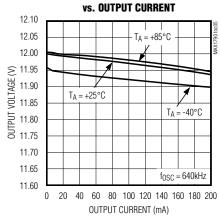


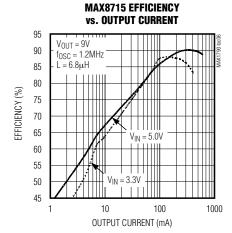


**MAX1790 OUTPUT VOLTAGE** 









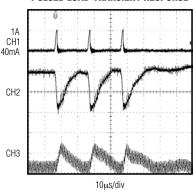
### **Typical Operating Characteristics (continued)**

(Circuit of Figure 1,  $V_{IN} = 3.3V$ ,  $f_{OSC} = 640kHz$ ,  $T_A = +25$ °C, unless otherwise noted.)

# 200mA CH1 0 RCOMP = 82kΩ CCOMP = 750PF CCOMP2 = 10pF CH3 CH3 40μs/div

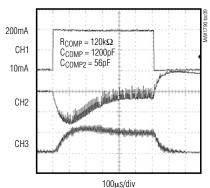
# CH1 = LOAD CURRENT, 200mA/div CH2 = OUTPUT VOLTAGE, AC-COUPLED, 100mV/div CH3 = INDUCTOR CURRENT, 500mA/div $V_{IN}$ = 3.3V, $V_{OUT}$ = 9.0V $f_{OSC}$ = 1.2MHz, L = 6.8 $\mu$ H, $C_{OUT}$ = 3 x 3.3 $\mu$ F

# MAX8715 PULSED LOAD-TRANSIENT RESPONSE



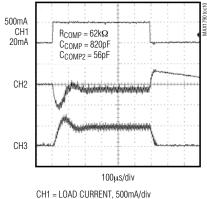
CH1 = LOAD CURRENT, 1A/div CH2 = OUTPUT VOLTAGE, AC-COUPLED, 100mV/div CH3 = INDUCTOR CURRENT, 500mA/div  $V_{IN}$  = 3.3V,  $V_{OUT}$  = 9.0V  $f_{OSC}$  = 1.2MHz, L = 6.8 $\mu$ H,  $C_{OUT}$  = 3 x 3.3 $\mu$ F

### **MAX1790 LOAD-TRANSIENT RESPONSE**



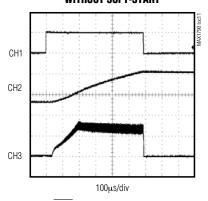
CH1 = LOAD CURRENT, 100mA/div CH2 = OUTPUT VOLTAGE, AC-COUPLED, 200mV/div CH3 = INDUCTOR CURRENT, 1A/div  $V_{IN}$  = 3V  $V_{OUT}$  = 12V,  $f_{OSC}$  = 640kHz,  $C_{OUT}$  = 33 $\mu$ F + 0.1 $\mu$ F

### MAX1790 LOAD-TRANSIENT RESPONSE



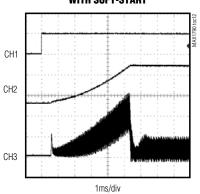
CH1 = LUAD CURENT, SOUTHAND OF THE LUAD CHEEN, SOUTHAND OF THE CH2 = OUTPUT VOLTAGE, AC-COUPLED, 200mV/div CH3 = INDUCTOR CURRENT, 1A/div VOUT = 5V, f0SC = 640kHz, COUT = 47µF + 0.1µF

### MAX1790 STARTUP WAVEFORM WITHOUT SOFT-START



 $\begin{array}{l} CH1 = \overline{SHDN}, 5V/div \\ CH2 = OUTPUT VOLTAGE, 5V/div \\ CH3 = INDUCTOR CURRENT, 1A/div \\ V_{IN} = 3.3V, V_{OUT} = 12V, I_{OUT} = 10mA, f_{OSC} = 640kHz \\ NO SOFT-START CAPACITOR, C_{OUT} = 33\mu F \end{array}$ 

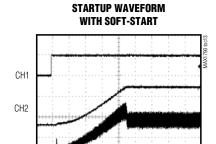
# STARTUP WAVEFORM WITH SOFT-START



$$\begin{split} & \text{CH1} = \overline{\text{SHDN}}, \, \text{5V/div} \\ & \text{CH2} = \text{OUTPUT VOLTAGE, 5V/div} \\ & \text{CH3} = \text{INDUCTOR CURRENT, 200mA/div} \\ & \text{V}_{\text{OUT}} = 12\text{V}, \, \text{I}_{\text{OUT}} = 10\text{mA}, \, \text{f}_{\text{OSC}} = 640\text{kHz}, \\ & \text{CSS} = 0.027 \mu\text{F}, \, \text{C}_{\text{OUT}} = 33 \mu\text{F} \end{split}$$

### **Typical Operating Characteristics (continued)**

(Circuit of Figure 1, V<sub>IN</sub> = 3.3V, f<sub>OSC</sub> = 640kHz, T<sub>A</sub> = +25°C, unless otherwise noted.)



 $CH1 = \overline{SHDN}, 5V/div$ 

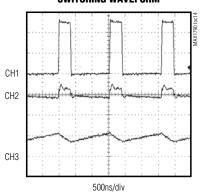
CH2 = V<sub>OUT</sub>, 5V/div

CH3 = INDUCTOR CURRENT, 500mA/div

 $V_{OUT} = 12V$ ,  $I_{OUT} = 200$ mA,  $f_{OSC} = 640$ kHz,  $C_{SS} = 0.027$  $\mu$ F

CH3

### **SWITCHING WAVEFORM**

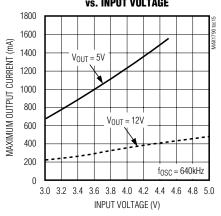


CH1 = LX SWITCHING WAVEFORM, 5V/div CH2 = OUTPUT VOLTAGE, AC-COUPLED, 200mV/div

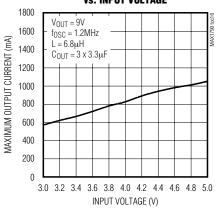
CH3 = INDUCTOR CURRENT, 1A/div

 $V_{OUT}$  = 12V,  $I_{OUT}$  = 200mA,  $f_{OSC}$  = 640kHz, L = 10 $\mu$ H;  $C_{OUT}$  = 33 $\mu$ F + 0.1 $\mu$ F

### **MAX1790 MAXIMUM OUTPUT CURRENT** vs. INPUT VOLTAGE



### **MAX8715 MAXIMUM OUTPUT CURRENT** vs. INPUT VOLTAGE



### **Pin Description**

PIN	NAME	FUNCTION
1	COMP	Compensation Pin for Error Amplifier. Connect a series RC from COMP to ground. See the <i>Loop Compensation</i> section for component selection guidelines.
2	FB	Feedback Pin. Reference voltage is 1.24V nominal. Connect an external resistor-divider tap to FB and minimize the trace area. Set V <sub>OUT</sub> according to: V <sub>OUT</sub> = 1.24V (1 + R1 / R2). See Figure 1.
3	SHDN	Shutdown Control Input. Drive SHDN low to turn off the MAX1790/MAX8715.
4	GND	Ground
5	LX	Switch Pin. Connect the inductor/catch diode to LX and minimize the trace area for lowest EMI.
6	IN	Supply Pin. Bypass IN with at least a 1µF ceramic capacitor directly to GND.
7	FREQ	Frequency Select Input. When FREQ is low, the oscillator frequency is set to 640kHz. When FREQ is high, the frequency is 1.2MHz. This input has a 5µA pulldown current.
8	SS	Soft-Start Control Pin. Connect a soft-start capacitor (Css) to this pin. Leave open for no soft-start. The soft-start capacitor is charged with a constant current of $4\mu A$ . Full current limit is reached after $t=2.5 \times 10^5$ Css. The soft-start capacitor is discharged to ground when $\overline{SHDN}$ is low. When $\overline{SHDN}$ goes high, the soft-start capacitor is charged to 0.5V, after which soft-start begins.

### **Detailed Description**

The MAX1790/MAX8715 are highly efficient power supplies that employ a current-mode, fixed-frequency PWM architecture for fast transient response and lownoise operation. The device regulates the output voltage through a combination of an error amplifier, two comparators, and several signal generators (Figure 2). The error amplifier compares the signal at FB to 1.24V and varies the COMP output. The voltage at COMP determines the current trip point each time the internal MOSFET turns on. As the load varies, the error amplifier sources or sinks current to the COMP output accordingly to produce the inductor peak current necessary to service the load. To maintain stability at high duty cycle, a slope-compensation signal is summed with the current-sense signal.

At light loads, this architecture allows the ICs to "skip" cycles to prevent overcharging the output voltage. In this region of operation, the inductor ramps up to a fixed peak value (approximately 50mA, MAX1790 or 75mA, MAX8715), discharges to the output, and waits until another pulse is needed again.

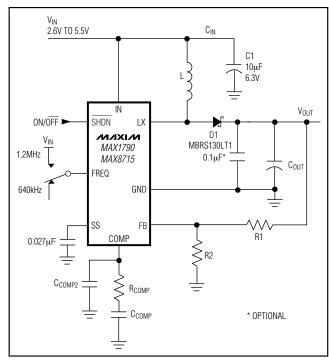


Figure 1. Typical Application Circuit

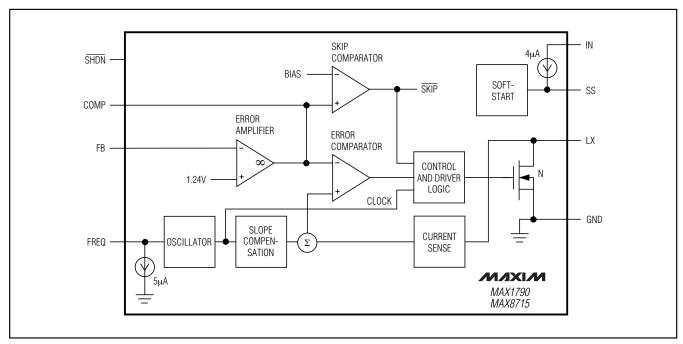


Figure 2. Functional Diagram

### **Output-Current Capability**

The output-current capability of the MAX1790/MAX8715 is a function of current limit, input voltage, operating frequency, and inductor value. Because of the slope compensation used to stabilize the feedback loop, the duty cycle affects the current limit. The output-current capability is governed by the following equation:

$$IOUT(MAX) = [ILIM \times (1.26 - 0.4 \times Duty) - 0.5 \times Duty \times VIN / (fOSC \times L)] \times \eta \times VIN / VOUT$$

where:

I<sub>LIM</sub> = current limit specified at 65% (see the *Electrical Characteristics*)

 $V_{DIODE}$  = catch diode forward voltage at  $I_{LIM}$   $\eta$  = conversion efficiency, 85% nominal

### Soft-Start

The MAX1790/MAX8715 can be programmed for soft-start upon power-up with an external capacitor. When the shutdown pin is taken high, the soft-start capacitor (Css) is immediately charged to 0.5V. Then the capacitor is charged at a constant current of  $4\mu A$  (typ). During this time, the SS voltage directly controls the peak inductor current, allowing 0A at Vss = 0.5V to the full current limit at Vss = 1.5V. The maximum load current is available

after the soft-start cycle is completed. When the shutdown pin is taken low, the soft-start capacitor is discharged to ground.

### **Frequency Selection**

The MAX1790/MAX8715s' frequency can be user selected to operate at either 640kHz or 1.2MHz. Connect FREQ to GND for 640kHz operation. For a 1.2MHz switching frequency, connect FREQ to IN. This allows the use of small, minimum-height external components while maintaining low output noise. FREQ has an internal pulldown, allowing the user the option of leaving FREQ unconnected for 640kHz operation.

### Shutdown

The MAX1790/MAX8715 are shut down to reduce the supply current to  $0.1\mu A$  when  $\overline{SHDN}$  is low. In this mode, the internal reference, error amplifier, comparators, and biasing circuitry turn off while the n-channel MOSFET is turned off. The boost converter's output is connected to IN by the external inductor and catch diode.

### \_Applications Information

Boost DC-DC converters using the MAX1790/MAX8715 can be designed by performing simple calculations for a first iteration. All designs should be prototyped and tested prior to production. Table 1 provides a list of

### **Table 1. Component Selection**

V <sub>IN</sub> (V)	V <sub>OUT</sub> (V)	fosc (Hz)	L (µH)	C <sub>OUT</sub> (µF)	R <sub>COMP</sub> (kΩ)	C <sub>COMP</sub> (pF)	C <sub>COMP2</sub> (pF)	I <sub>OUT(MAX)</sub> (mA)
MAX179	0							
3.3	12	640k	10 (Sumida CDRH5D18-100NC)	33 tantalum (AVX TPSD336020R0200)	120	1200	22	250
3.3	12	1.2M	5.4 (Sumida CDRH5D18-5R4NC)	33 tantalum (AVX TPSD336020R0200)	180	650	20	250
3.3	5	640k	5.4 (Sumida CDRH5D18-5R4NC)	47 tantalum (6TPA47M)	62	820	56	800
3.3	5	1.2M	2.7 (Sumida CDRH4D18-2R7)	47 tantalum (6TPA47M)	91	390	33	800
MAX8715								
3.3	9	1.2M	6.8 (Sumida CLQ4D10-6R8)	3 x 3.3 ceramic (Taiyo Yuden LMK325BJ335MD)	82	750	10	150

### **Table 2. Component Suppliers**

SUPPLIER	PHONE	FAX							
Inductors	Inductors								
Coilcraft	847-639-6400	847-639-1469							
Coiltronics	561-241-7876	561-241-9339							
Sumida USA	847-956-0666	847-956-0702							
TOKO	847-297-0070	847-699-1194							
Capacitors									
AVX	803-946-0690	803-626-3123							
Kemet	408-986-0424	408-986-1442							
Sanyo	619-661-6835	619-661-1055							
Taiyo Yuden	408-573-4150	408-573-4159							
Diodes									
Central Semiconductor	516-435-1110	516-435-1824							
International Rectifier	310-322-3331	310-322-3332							
Motorola	602-303-5454	602-994-6430							
Nihon	847-843-7500	847-843-2798							
Zetex	516-543-7100	516-864-7630							

components for a range of standard applications. Table 2 lists component suppliers.

External component value choice is primarily dictated by the output voltage and the maximum load current,

as well as maximum and minimum input voltages. Begin by selecting an inductor value. Once L is known, choose the diode and capacitors.

### **Inductor Selection**

The minimum inductance value, peak current rating, and series resistance are factors to consider when selecting the inductor. These factors influence the converter's efficiency, maximum output load capability, transient-response time, and output voltage ripple. Physical size and cost are also important factors to be considered.

The maximum output current, input voltage, output voltage, and switching frequency determine the inductor value. Very high inductance values minimize the current ripple and therefore reduce the peak current, which decreases core losses in the inductor and I<sup>2</sup>R losses in the entire power path. However, large inductor values also require more energy storage and more turns of wire, which increase physical size and can increase I<sup>2</sup>R losses in the inductor. Low inductance values decrease the physical size but increase the current ripple and peak current. Finding the best inductor involves choosing the best compromise between circuit efficiency, inductor size, and cost.

The equations used here include a constant LIR, which is the ratio of the inductor peak-to-peak ripple current to the average DC inductor current at the full load current. The best trade-off between inductor size and circuit efficiency for step-up regulators generally has an LIR between 0.3 and 0.5. However, depending on the AC characteristics of the inductor core material and the

ratio of inductor resistance to other power path resistances, the best LIR can shift up or down. If the inductor resistance is relatively high, more ripple can be accepted to reduce the number of turns required and increase the wire diameter. If the inductor resistance is relatively low, increasing inductance to lower the peak current can decrease losses throughout the power path. If extremely thin high-resistance inductors are used, as is common for LCD-panel applications, the best LIR can increase to between 0.5 and 1.0.

Once a physical inductor is chosen, higher and lower values of the inductor should be evaluated for efficiency improvements in typical operating regions.

Calculate the approximate inductor value using the typical input voltage ( $V_{IN}$ ), the maximum output current ( $I_{MAIN(MAX)}$ ), the expected efficiency ( $\eta_{TYP}$ ) taken from an appropriate curve in the *Typical Operating Characteristics*, and an estimate of LIR based on the above discussion:

$$L = \left(\frac{V_{IN}}{V_{MAIN}}\right)^{2} \left(\frac{V_{MAIN} - V_{IN}}{I_{MAIN(MAX)} \times f_{OSC}}\right) \left(\frac{\eta_{TYP}}{LIR}\right)$$

Choose an available inductor value from an appropriate inductor family. Calculate the maximum DC input current at the minimum input voltage  $V_{\text{IN(MIN)}}$  using conservation of energy and the expected efficiency at that operating point ( $\eta_{\text{MIN}}$ ) taken from an appropriate curve in the *Typical Operating Characteristics*:

$$I_{\text{IN(DC,MAX)}} = \frac{I_{\text{MAIN(MAX)}} \times V_{\text{MAIN}}}{V_{\text{IN(MIN)}} \times \eta_{\text{MIN}}}$$

Calculate the ripple current at that operating point and the peak current required for the inductor:

$$I_{RIPPLE} = \frac{V_{IN(MIN)} \times (V_{MAIN} - V_{IN(MIN)})}{L \times V_{MAIN} \times f_{OSC}}$$

$$I_{PEAK} = I_{IN(DC,MAX)} + \frac{I_{RIPPLE}}{2}$$

The inductor's saturation current rating and the MAX1790/MAX8715s' LX current limit ( $I_{LIM}$ ) should exceed  $I_{PEAK}$  and the inductor's DC current rating should exceed  $I_{IN(DC,MAX)}$ . For good efficiency, choose an inductor with less than  $0.1\Omega$  series resistance.

Considering the application circuit in Figure 4, the maximum load current (IMAIN(MAX)) is 150mA with a 9V output and a typical input voltage of 3.3V. Choosing an LIR of 0.5 and estimating efficiency of 85% at this operating point:

$$L = \left(\frac{3.3V}{9V}\right)^2 \left(\frac{9V - 3.3V}{0.15A \times 1.2MHz}\right) \left(\frac{0.85}{0.5}\right) \approx 6.8\mu H$$

Using the circuit's minimum input voltage (3V) and estimating efficiency of 80% at that operating point:

$$I_{IN(DC,MAX)} = \frac{0.15A \times 9V}{3V \times 0.8} \approx 0.6A$$

The ripple current and the peak current are:

$$I_{RIPPLE} = \frac{3V \times (9V - 3V)}{6.8\mu H \times 9V \times 1.2MHz} \approx 0.25A$$

$$I_{PEAK} = 0.6A + \frac{0.25A}{2} \approx 0.725A$$

### **Diode Selection**

The output diode should be rated to handle the output voltage and the peak switch current. Make sure that the diode's peak current rating is at least IpK and that its breakdown voltage exceeds VOUT. Schottky diodes are recommended.

### **Input and Output Capacitor Selection**

Low-ESR capacitors are recommended for input bypassing and output filtering. Low-ESR tantalum capacitors are a good compromise between cost and performance. Ceramic capacitors are also a good choice. Avoid standard aluminum electrolytic capacitors. A simple equation to estimate input and outputcapacitor values for a given voltage ripple is as follows:

$$C \ge \frac{0.5 \times L \times (IPK^2)}{V_{RIPPLE} \times V_{OUT}}$$

where V<sub>RIPPLE</sub> is the peak-to-peak ripple voltage on the capacitor.

### **Output Voltage**

The MAX1790/MAX8715 operate with an adjustable output from V<sub>IN</sub> to 13V. Connect a resistor voltage-divider to FB (see the *Typical Operating Circuit*) from the output to GND. Select the resistor values as follows:

$$R1 = R2 \left( \frac{V_{OUT}}{V_{FB}} - 1 \right)$$

where VFB, the boost-regulator feedback set point, is 1.24V. Since the input bias current into FB is typically 0,

R2 can have a value up to  $100k\Omega$  without sacrificing accuracy. Connect the resistor-divider as close to the IC as possible.

### **Loop Compensation**

The voltage feedback loop needs proper compensation to prevent excessive output ripple and poor efficiency caused by instability. This is done by connecting a resistor (RCOMP) and capacitor (CCOMP) in series from COMP to GND, and another capacitor (CCOMP2) from COMP to GND. RCOMP is chosen to set the high-frequency integrator gain for fast transient response, while CCOMP is chosen to set the integrator zero to maintain loop stability. The second capacitor, CCOMP2, is chosen to cancel the zero introduced by output-capacitance ESR. For optimal performance, choose the components using the following equations:

 $R_{COMP} \approx (200\Omega / A^2) \times V_{OUT}^2 \times C_{OUT} / L \quad (MAX1790)$ 

 $R_{COMP} \approx (274\Omega / A) \times V_{IN} \times V_{OUT} \times C_{OUT} / (L \times I_{OUT})$ (MAX8715)

 $C_{COMP} \cong (0.4 \times 10^{-3} \text{ A/}\Omega) \times L / V_{IN}$  (MAX1790)

 $C_{COMP} \cong (0.36 \times 10^{-3} \text{ A/}\Omega) \times L / V_{IN}$  (MAX8715)

 $C_{COMP2} \cong (0.005 \text{ A}^2/\Omega) \times RESR \times L / V_{OUT}^2$ (MAX1790)

 $C_{COMP2} \cong (0.0036 \text{ A/}\Omega) \times R_{ESR} \times L \times I_{OUT} / (V_{IN} \times V_{OUT})$ (MAX8715)

For the ceramic output capacitor, where ESR is small, CCOMP2 is optional. Table 1 shows experimentally verified external component values for several applications. The best gauge of correct loop compensation is by inspecting the transient response of the MAX1790/MAX8715. Adjust RCOMP and CCOMP as necessary to obtain optimal transient performance.

### **Soft-Start Capacitor**

The soft-start capacitor should be large enough that it does not reach final value before the output has reached regulation. Calculate Css to be:

$$C_{SS} \ > \ 21 \ \times \ 10^{-6} \ \times \ C_{OUT} \ \left( \frac{V_{OUT}{}^2 \ - \ V_{IN} \ \times \ V_{OUT}}{V_{IN} \ \times \ I_{INRUSH} \ - \ I_{OUT} \ \times \ V_{OUT}} \right)$$

### where:

Cout = total output capacitance including any bypass capacitor on the output bus

VOUT = maximum output voltage

INRUSH = peak inrush current allowed

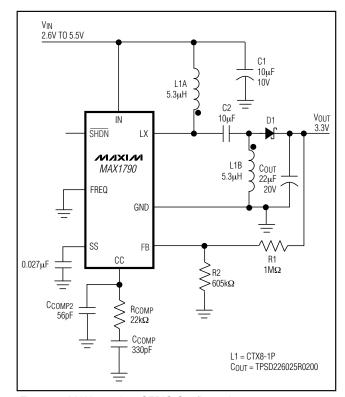


Figure 3. MAX1790 in a SEPIC Configuration

 $I_{OUT}$  = maximum output current during power-up stage  $V_{IN}$  = minimum input voltage

The load must wait for the soft-start cycle to finish before drawing a significant amount of load current. The duration after which the load can begin to draw maximum load current is:

$$t_{MAX} = 6.77 \times 10^5 \, Css$$

# Application Circuits 1-Cell to 3.3V SEPIC Power Supply

Figure 3 shows the MAX1790 in a single-ended primary inductance converter (SEPIC) topology. This topology is useful when the input voltage can be either higher or lower than the output voltage, such as when converting a single lithium-ion (Li+) cell to a 3.3V output. L1A and L1B are two windings on a single inductor. The coupling capacitor between these two windings must be a low-ESR type to achieve maximum efficiency, and must also be able to handle high ripple currents. Ceramic capacitors are best for this application. The circuit in Figure 3 provides 400mA output current at 3.3V output when operating with an input voltage from +2.6V to +5.5V.

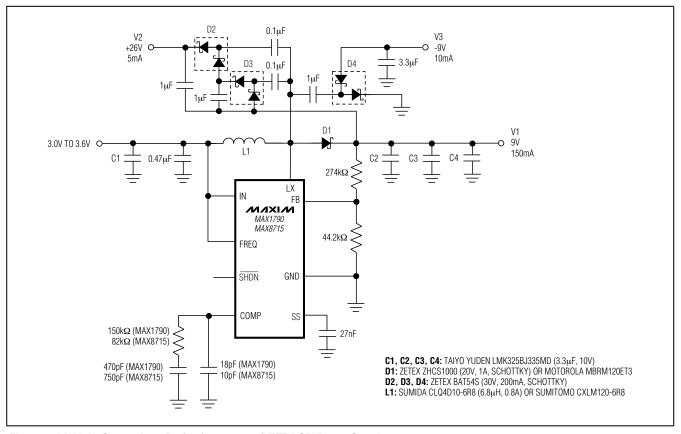


Figure 4. Multiple-Output, Low-Profile (1.2mm max) TFT-LCD Power Supply

### AMLCD Application

Figure 4 shows a power supply for active matrix (TFT-LCD) flat-panel displays. Output-voltage transient performance is a function of the load characteristic. Add or remove output capacitance (and recalculate compensation-network component values) as necessary to meet transient performance. Regulation performance for secondary outputs (V2 and V3) depends on the load characteristics of all three outputs.

### **Layout Procedure**

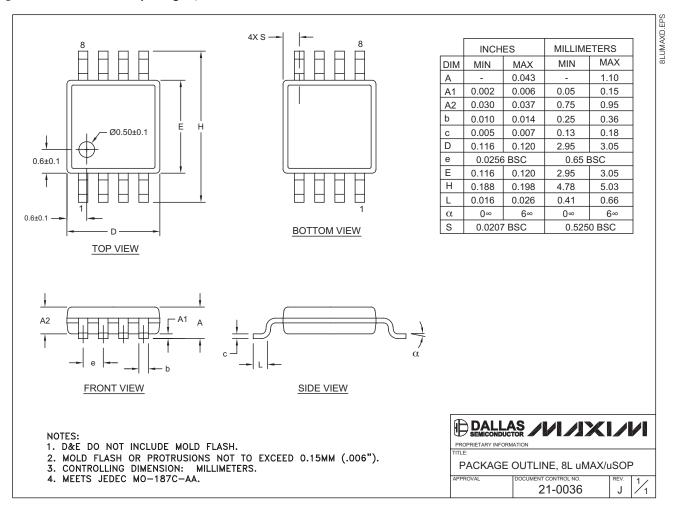
Good PC board layout and routing are required in highfrequency switching power supplies to achieve good regulation, high efficiency, and stability. It is strongly recommended that the evaluation kit PC board layouts be followed as closely as possible. Place power components as close together as possible, keeping their traces short, direct, and wide. Avoid interconnecting the ground pins of the power components using vias through an internal ground plane. Instead, keep the power components close together and route them in a star ground configuration using component-side copper, then connect the star ground to internal ground using multiple vias.

\_Chip Information

TRANSISTOR COUNT: 1012

### **Package Information**

(The package drawing(s) in this data sheet may not reflect the most current specifications. For the latest package outline information, go to www.maxim-ic.com/packages.)



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